

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74VHCT240AF, TC74VHCT240AFW, TC74VHCT240AFT

TC74VHCT244AF, TC74VHCT244AFW, TC74VHCT244AFT

OCTAL BUS BUFFER**TC74VHCT240AF / AFW / AFT INVERTED, 3 - STATE OUTPUTS****TC74VHCT244AF / AFW / AFT NON - INVERTED, 3 - STATE OUTPUTS**

(Note) The JEDEC SOP (FW) is not available in Japan.

The TC74VHCT240A and 244A are advanced high speed CMOS OCTAL BUS BUFFERS fabricated with silicon gate CMOS technology. They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74VHCT240A is an inverting 3 - state buffer having two active - low output enables. The TC74VHCT244A is a non - inverting 3 - state buffer, and has two active - low output enables.

These devices are designed to be used with 3 - state memory address drivers, etc.

The input voltage are compatible with TTL output voltage.

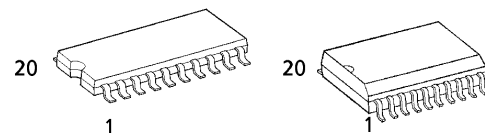
These devices may be used as a level converter for interfacing 3.3V to 5V system.

Input protection and output circuit ensure that 0 to 5.5V can be applied to the input and output*1 pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input / output voltages such as battery back up, hot board insertion, etc.

*1: output in off-state

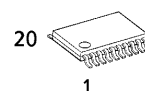
FEATURES:

- High Speed..... $t_{pd} = 6.1\text{ns}(\text{typ.})$ at $V_{CC} = 5\text{V}$
- Low Power Dissipation..... $I_{CC} = 4\mu\text{A}(\text{Max.})$ at $T_a = 25^\circ\text{C}$
- Compatible with TTL outputs ... $V_{IL} = 0.8\text{V}(\text{Max.})$
 $V_{IH} = 2.0\text{V}(\text{Min.})$
- Power Down Protection is provided on all inputs and outputs
- Balanced Propagation Delays..... $t_{pLH} \approx t_{pHL}$
- Low Noise $V_{OLP} = 1.0\text{V}(\text{Max.})$
- Pin and Function Compatible with the 74 series (74AC / HC / F / ALS / LS etc.) 240 / 244 type.



F (SOP20-P-300-1.27)
Weight : 0.22g (Typ.)

FW (SOL20-P-300-1.27)
Weight : 0.46g (Typ.)



FT (TSSOP20-P-0044-0.65)
Weight : 0.08g (Typ.)

TRUTH TABLE

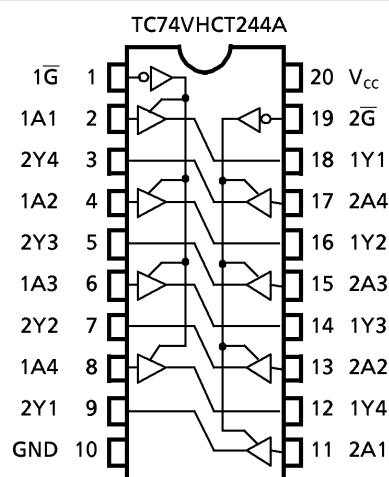
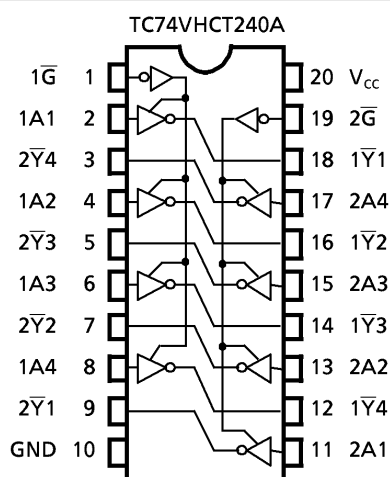
INPUTS		OUTPUTS	
$\overline{G}$	A_n	Y_n	$\overline{Y}_n$
L	L	L	H
L	H	H	L
H	X	Z	Z

X : Don't Care

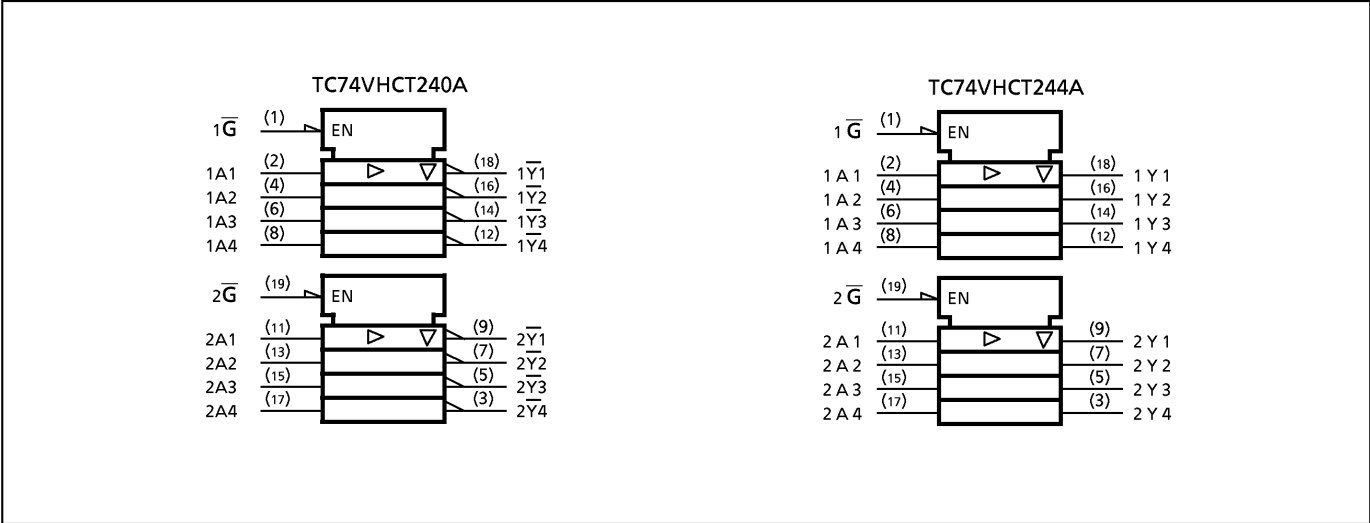
Z : High Impedance

Y_n : TC74VHCT244A

$\overline{Y}_n$: TC74VHCT240A

PIN ASSIGNMENT

IEC LOGIC SYMBOL



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V_{CC}	$-0.5 \sim 7.0$	V
DC Input Voltage	V_{IN}	$-0.5 \sim 7.0$	V
DC Output Voltage	V_{OUT}	$-0.5 \sim 7.0$ (Note 1)	V
		$-0.5 \sim V_{CC} + 0.5$ (Note 2)	
Input Diode Current	I_{IK}	-20	mA
Output Diode Current	I_{OK}	± 20 (Note 3)	mA
DC Output Current	I_{OUT}	± 25	mA
DC Vcc/Ground Current	I_{CC}	± 75	mA
Power Dissipation	P_D	180	mW
Storage Temperature	T_{stg}	$-65 \sim 150$	$^{\circ}C$

- (Note 1) Output in Off-State
- (Note 2) High or Low State. I_{OUT} absolute maximum rating must be observed.
- (Note 3) $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V_{CC}	4.5~5.5	V
Input Voltage	V_{IN}	0~5.5	V
Output Voltage	V_{OUT}	0~5.5 (Note 4)	V
		0~ V_{CC} (Note 5)	
Operating Temperature	T_{opr}	$-40 \sim 85$	$^{\circ}C$
Input Rise and Fall Time	dt/dV	0~20	ns/V

- (Note 4) Output in Off-State
- (Note 5) High or Low State

DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITON		V _{CC} (V)	Ta = 25°C			Ta = -40~85°C		UNIT
					MIN.	TYP.	MAX.	MIN.	MAX.	
High - Level Input Voltage	V _{IH}			4.5~5.5	2.0	—	—	2.0	—	V
Low - Level Input Voltage	V _{IL}			4.5~5.5	—	—	0.8	—	0.8	V
High - Level Output Voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μ A	4.5	4.40	4.50	—	4.40	—	V
			I _{OH} = -8mA	4.5	3.94	—	—	3.80	—	
Low - Level Output Voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μ A	4.5	—	0.0	0.10	—	0.10	V
			I _{OL} = 8mA	4.5	—	—	0.36	—	0.44	
3 - State Output Off - State Current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	—	—	± 0.25	—	± 2.50	μ A
Input Leakage Current	I _{IN}	V _{IN} = 5.5V or GND		0~5.5	—	—	± 0.1	—	± 1.0	
Quiescent Supply Current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	—	—	4.0	—	40.0	
	I _{CCT}	PER INPUT : V _{IN} = 3.4V OTHER INPUT : V _{CC} or GND		5.5	—	—	1.35	—	1.50	mA
Output Leakage Current	I _{OPD}	V _{OUT} = 5.5V		0	—	—	+ 0.5	—	+ 5.0	μ A

AC ELECTRICAL CHARACTERISTICS (Input t_r = t_f = 3ns)

PARAMETER	SYMBOL	TEST CONDITION			Ta = 25°C			Ta = -40~85°C		UNIT
			V _{CC} (V)	C _L (pF)	MIN.	TYP.	MAX.	MIN.	MAX.	
Propagation Delay Time (TC74VHCT240A)	t _{pLH} t _{pHL}		5.0 $\pm$ 0.5	15	—	5.6	7.8	1.0	9.0	ns
				50	—	6.1	8.8	1.0	10.0	
Propagation Delay Time (TC74VHCT244A)	t _{pLH} t _{pHL}		5.0 $\pm$ 0.5	15	—	5.4	7.4	1.0	8.5	
				50	—	5.9	8.4	1.0	9.5	
3-State Output Enable Time	t _{pZL} t _{pZH}	R _L = 1k Ω	5.0 $\pm$ 0.5	15	—	7.7	10.4	1.0	12.0	
				50	—	8.2	11.4	1.0	13.0	
3-State Output Disable Time	t _{pLZ} t _{pHZ}	R _L = 1k Ω	5.0 $\pm$ 0.5	50	—	8.8	11.4	1.0	13.0	pF
Output to Output Skew	t _{osLH} t _{osHL}	(Note 6)	5.0 $\pm$ 0.5	50	—	—	1.0	—	1.0	
Input Capacitance	C _{IN}				—	4	10	—	10	
Output Capacitance	C _{OUT}				—	9	—	—	—	
Power Dissipation Capacitance (Note 7)	C _{PD}	TC74VHCT240A			—	19	—	—	—	
		TC74VHCT244A			—	18	—	—	—	

(Note 6) Parameter guaranteed by design. $t_{osLH} = |t_{pLHm} - t_{pLHn}|$, $t_{osHL} = |t_{pHLm} - t_{pHLn}|$

(Note 7) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC(opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 8 \text{ (per bit)}$$

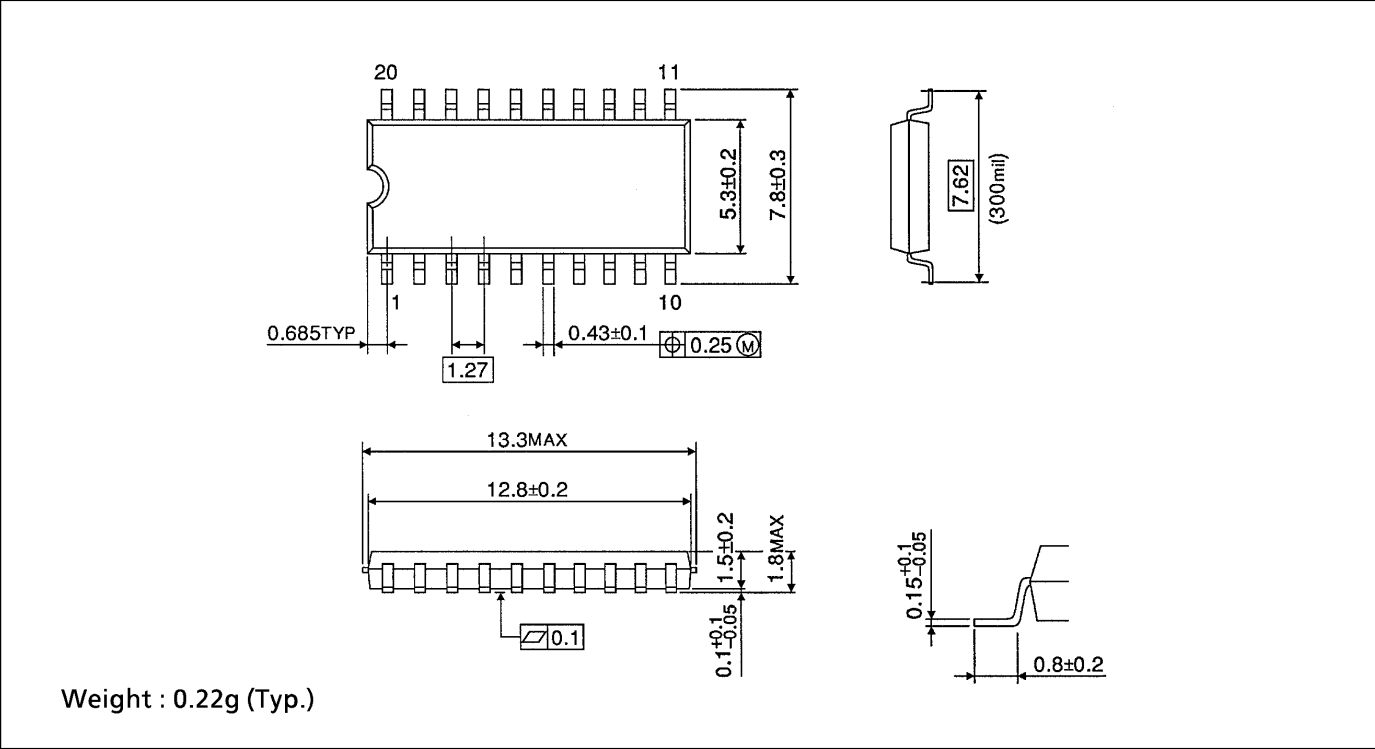
NOISE CHARACTERISTICS (Input $t_r = t_f = 3\text{ns}$)

PARAMETER	SYMBOL	TEST CONDITION		Ta = 25°C		UNIT
			V _{CC} (V)	TYP.	LIMIT	
Quiet Output Maximum Dynamic V _{OL}	V _{OLP}	C _L = 50pF	5.0	0.8 (0.9)	1.0 (1.1)	V
Quiet Output Minimum Dynamic V _{OL}	V _{OLV}	C _L = 50pF	5.0	− 0.8 (− 0.9)	− 1.0 (− 1.1)	V
Minimum High Level Dynamic Input Voltage	V _{IHD}	C _L = 50pF	5.0	—	2.0	V
Maximum Low Level Dynamic Input Voltage	V _{ILD}	C _L = 50pF	5.0	—	0.8	V

(Note) The value in () only applies to JEDEC SOP (FW) devices.

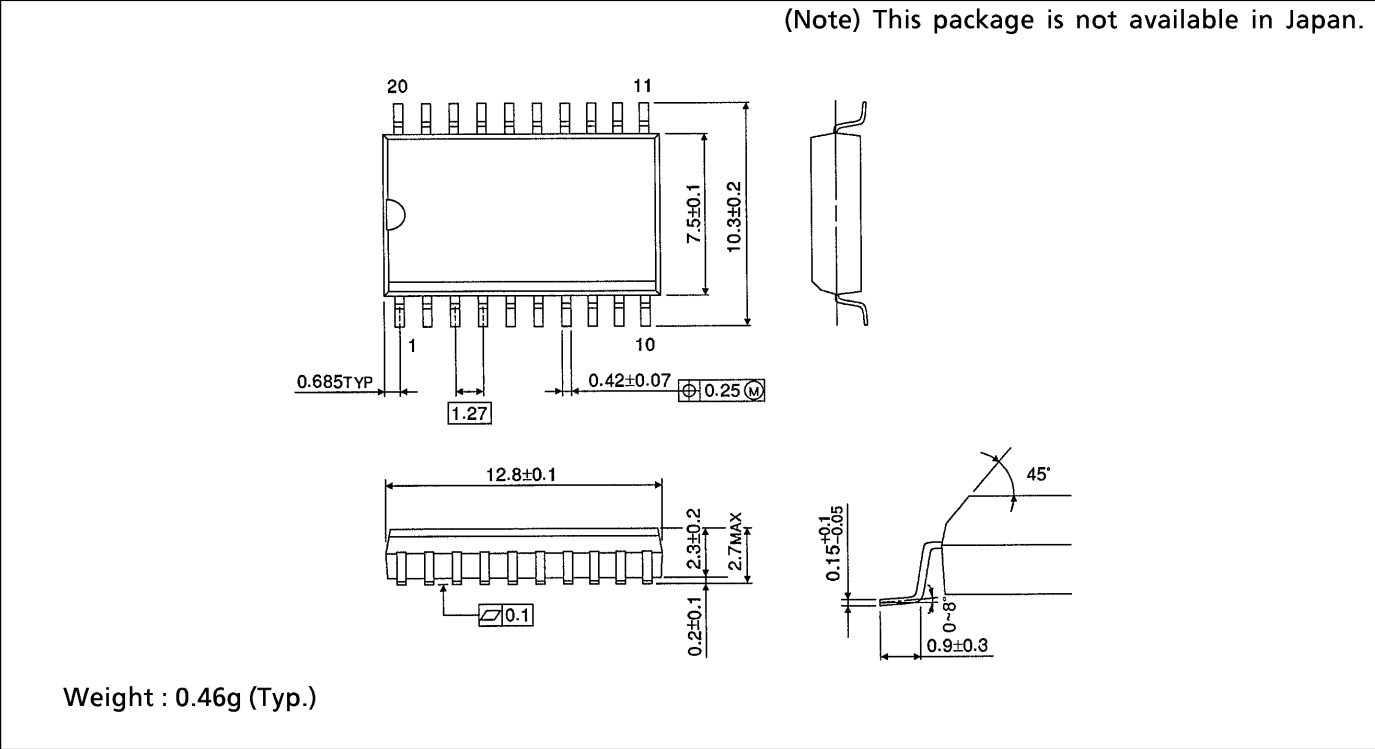
SOP 20PIN (200mil BODY) PACKAGE DIMENSIONS (SOP20-P-300-1.27)

Unit in mm



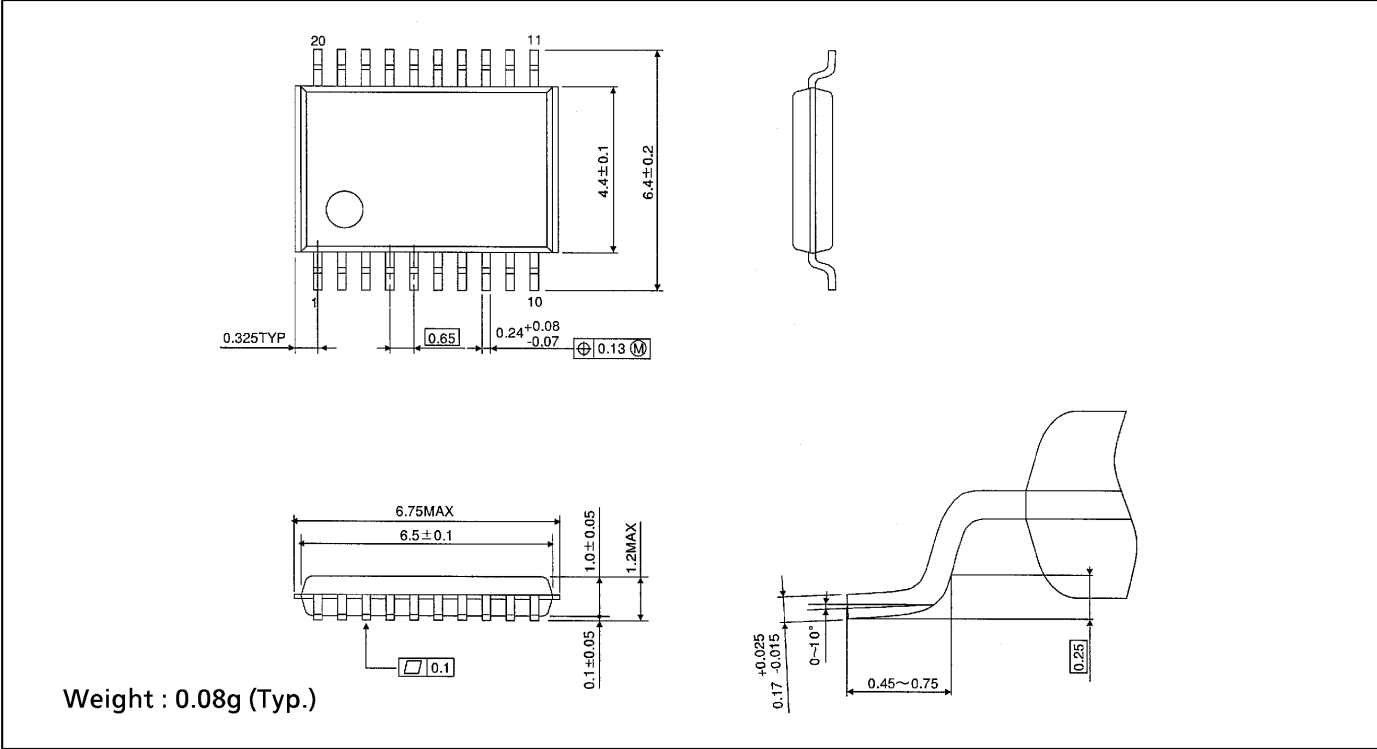
SOP 20PIN (300mil BODY) PACKAGE DIMENSIONS (SOL20-P-300-1.27)

Unit in mm



TSSOP 20PIN PACKAGE DIMENSIONS (TSSOP20-P-0044-0.65)

Unit in mm



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